

# FFB3904 / FMB3904 / MMPQ3904 NPN Multi-Chip General Purpose Amplifier

## Description

This device is designed as a general purpose amplifier and switch. The useful dynamic range extends to 100 mA as a switch and to 100 MHz as an amplifier. Sourced from Process 23.

## Ordering Information

Part Number	Top Mark	Package	Packing Method
2N5551TA	5551	TO-92 3L	Ammo
2N5551TFR	5551	TO-92 3L	Tape and Reel
2N5551TF	5551	TO-92 3L	Tape and Reel

## Block Diagram

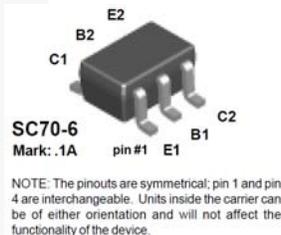


Figure 1. FFB3904 Device Package

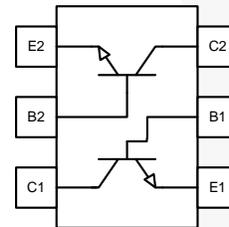


Figure 2. FFB3904 Internal Connection

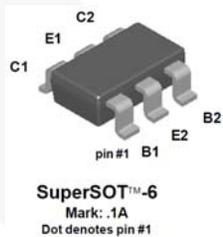


Figure 3. FMB3904 Device Package

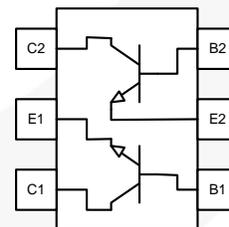


Figure 4. FMB3904 Internal Connection

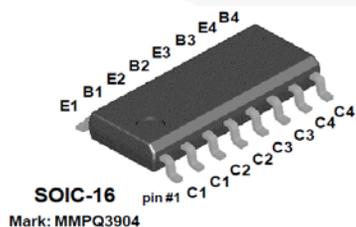


Figure 5. MMPQ3904 Device Package

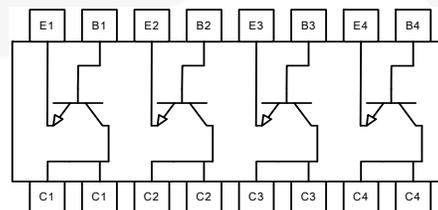


Figure 6. MMPQ3904 Internal Connection

## Absolute Maximum Ratings<sup>(1)</sup>

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at  $T_A = 25^\circ\text{C}$  unless otherwise noted.

Symbol	Parameter	Value	Units
$V_{CEO}$	Collector-Emitter Voltage	40	V
$V_{CBO}$	Collector-Base Voltage	60	V
$V_{EBO}$	Emitter-Base Voltage	6.0	V
$I_C$	Collector current - Continuous	200	mA
$T_J, T_{stg}$	Junction and Storage Temperature	-55 to +150	$^\circ\text{C}$

### Notes:

- These ratings are based on a maximum junction temperature of  $150^\circ\text{C}$ .  
These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed or low-duty cycle operations.  
All voltages (V) and currents (A) are negative polarity for PNP transistors.

## Thermal Characteristics<sup>(2)</sup>

Values are at  $T_A = 25^\circ\text{C}$  unless otherwise noted.

Symbol	Parameter	Maximum			Units
		FFB3904	FMB3904	MMPQ3904	
$P_D$	Total Device Dissipation	300	700	1,000	mW
	Derate above $25^\circ\text{C}$	2.4	5.6	8.0	mW/ $^\circ\text{C}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	415	180		$^\circ\text{C}/\text{W}$
	Effective 4 Die			125	$^\circ\text{C}/\text{W}$
	Each Die			240	$^\circ\text{C}/\text{W}$

### Note:

- PCB Board Size: FR-4 76 x 114 x 0.6T mm<sup>3</sup>(3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

### Electrical Characteristics<sup>(3)</sup>

Values are at  $T_A = 25^\circ\text{C}$  unless otherwise noted.

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
<b>Off Characteristics</b>						
$V_{(BR)CEO}$	Collector-Emitter Breakdown Voltage	$I_C = 1.0\text{ mA}, I_B = 0$	40			V
$V_{(BR)CBO}$	Collector-Base Breakdown Voltage	$I_C = 10\ \mu\text{A}, I_E = 0$	60			V
$V_{(BR)EBO}$	Emitter-Base Breakdown Voltage	$I_E = 10\ \mu\text{A}, I_C = 0$	6.0			V
$I_{BL}$	Base Cut-Off Current	$V_{CE} = 30\text{ V}, I_E = 0$			50	nA
$I_{CEX}$	Collector Cut-Off Current	$V_{CE} = 30\text{ V}, I_C = 0$			50	nA
<b>On Characteristics<sup>(4)</sup></b>						
$h_{FE}$	DC Current Gain	$I_C = 0.1\text{ mA}, V_{CE} = 1.0\text{ V}$	40		300	
		MMPQ3904	30			
		$I_C = 1.0\text{ mA}, V_{CE} = 1.0\text{ V}$	70			
		MMPQ3904	50			
		$I_C = 10\text{ mA}, V_{CE} = 1.0\text{ V}$	100			
		MMPQ3904	75			
		$I_C = 50\text{ mA}, V_{CE} = 1.0\text{ V}$	60			
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = 10\text{ mA}, I_B = 1.0\text{ mA}$			0.2	V
		$I_C = 50\text{ mA}, I_B = 5.0\text{ mA}$			0.3	V
$V_{BE(sat)}$	Base-Emitter On Voltage	$I_C = 10\text{ mA}, I_B = 1.0\text{ mA}$	0.65		0.85	V
		$I_C = 50\text{ mA}, I_B = 5.0\text{ mA}$			0.95	V
<b>Small-Signal Characteristics</b>						
$f_T$	Current Gain-Bandwidth Product	$I_C = 10\text{ mA}, V_{CE} = 20\text{ V}, f = 100\text{ MHz}$		250		MHz
$C_{obo}$	Output Capacitance	$V_{CB} = 5.0\text{ V}, I_E = 0, f = 140\text{ MHz}$		4.0		pF
$C_{ibo}$	Input Capacitance	$V_{BE} = 0.5\text{ V}, I_C = 0, f = 140\text{ MHz}$		8.0		pF

**Notes:**

3. All voltages (V) and currents (A) are negative polarity for PNP transistors.
4. Pulse Test: Pulse width  $\leq 300\ \mu\text{s}$ , duty cycle  $\leq 2.0\%$ .

### Typical Performance Characteristics

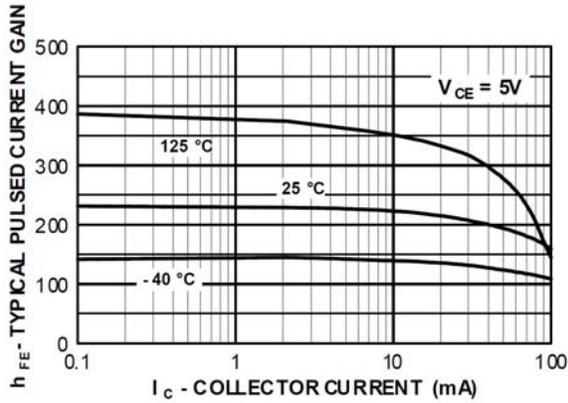


Figure 7. Typical Pulsed Current Gain vs. Collector Current

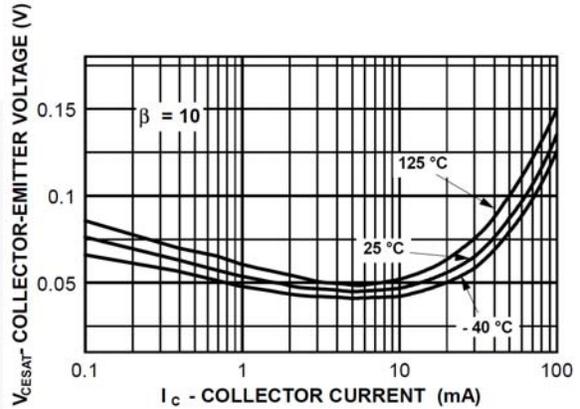


Figure 8. Collector-Emitter Saturation Voltage vs. Collector Current

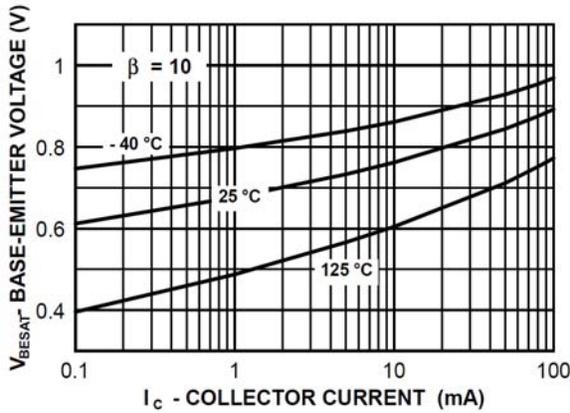


Figure 9. Base-Emitter Saturation Voltage vs. Collector Current

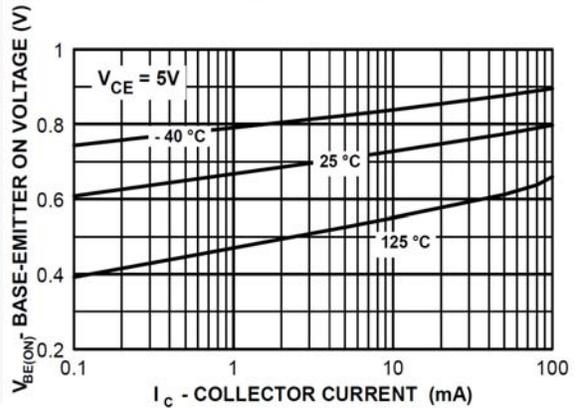


Figure 10. Base-Emitter ON Voltage vs. Collector Current

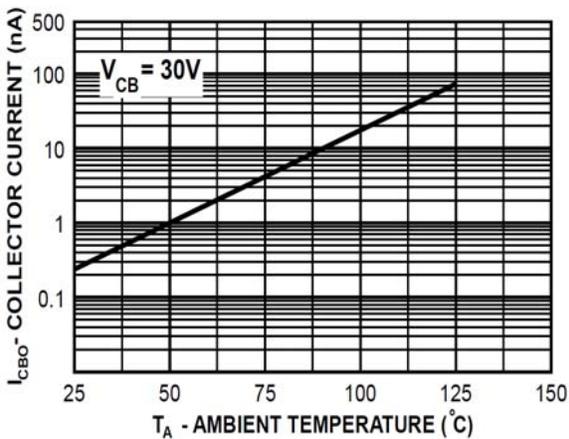


Figure 11. Collector Cut-Off Current vs. Ambient Temperature

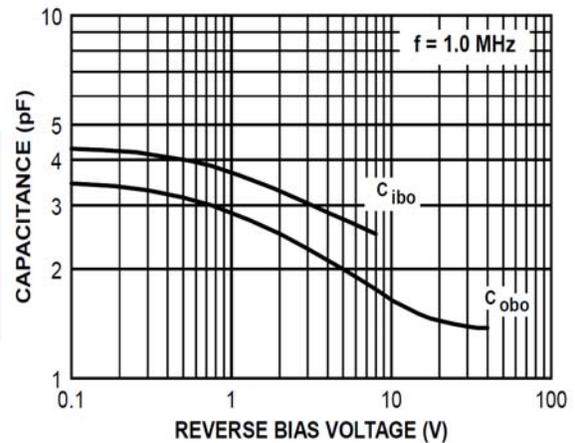


Figure 12. Capacitance vs. Reverse Bias Voltage

**Typical Performance Characteristics (Continued)**

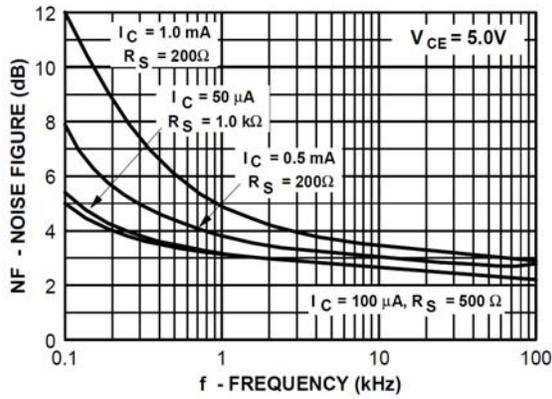


Figure 13. Noise Figure vs. Frequency

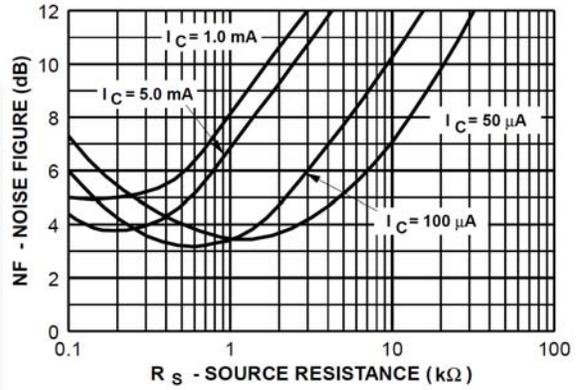


Figure 14. Noise Figure vs. Source Resistance

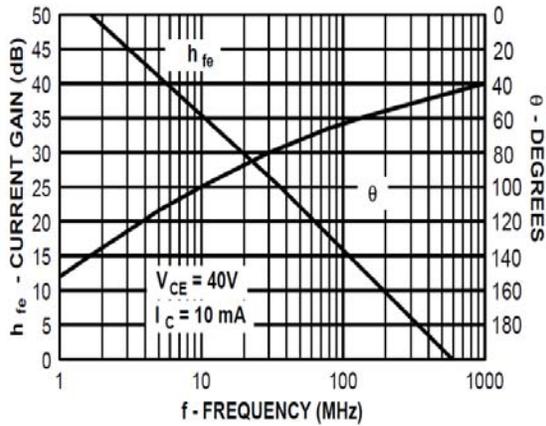


Figure 15. Current Gain and Phase Angle vs. Frequency

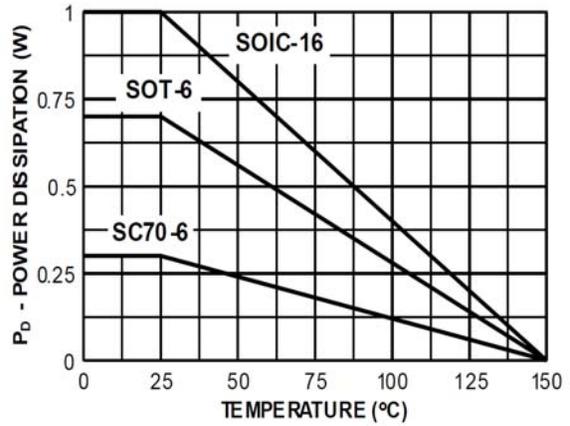


Figure 16. Power Dissipation vs. Ambient Temperature

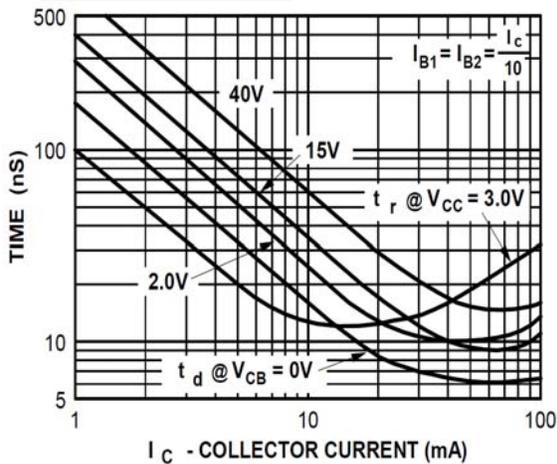


Figure 17. Turn-On Time vs. Collector Current

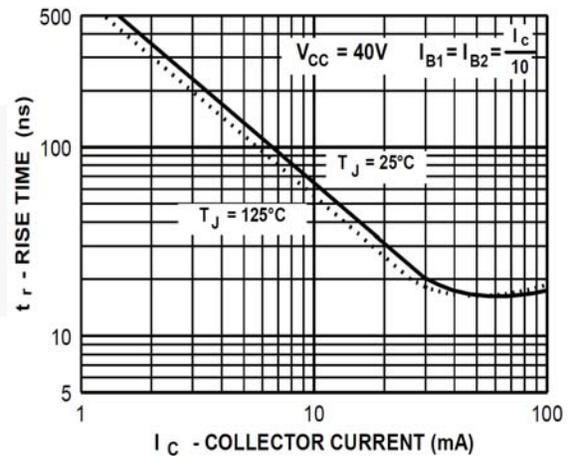
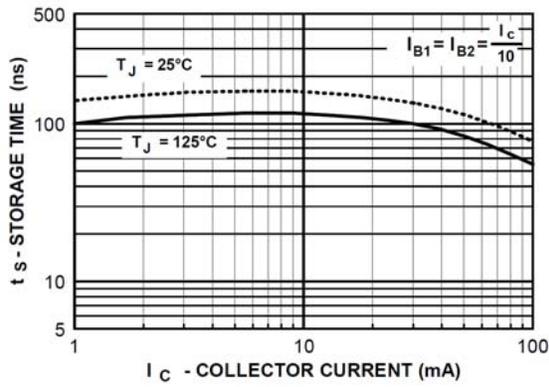
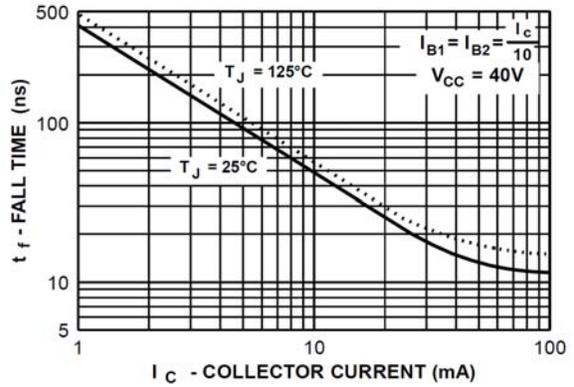


Figure 18. Rise Time vs. Collector Current

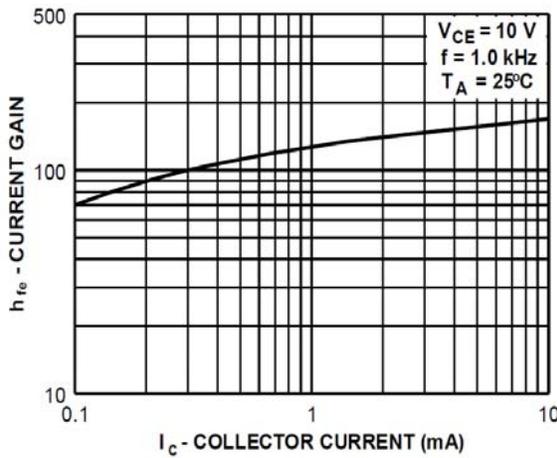
**Typical Performance Characteristics (Continued)**



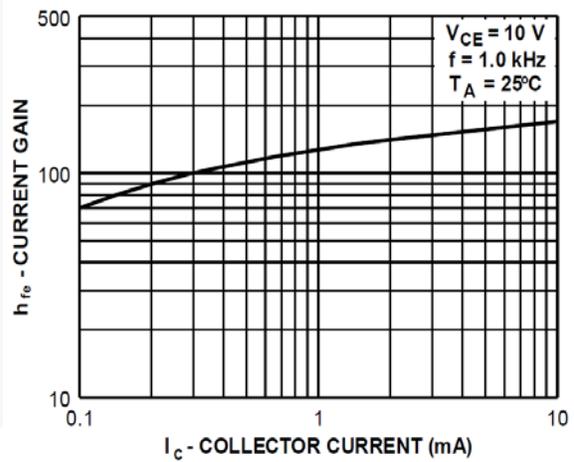
**Figure 19. Storage Time vs. Collector Current**



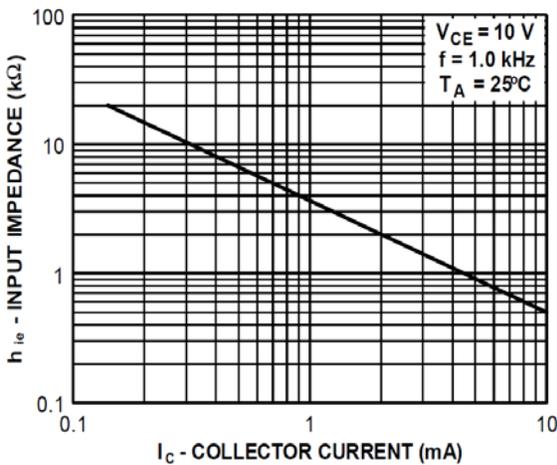
**Figure 20. Fall Time vs. Collector Current**



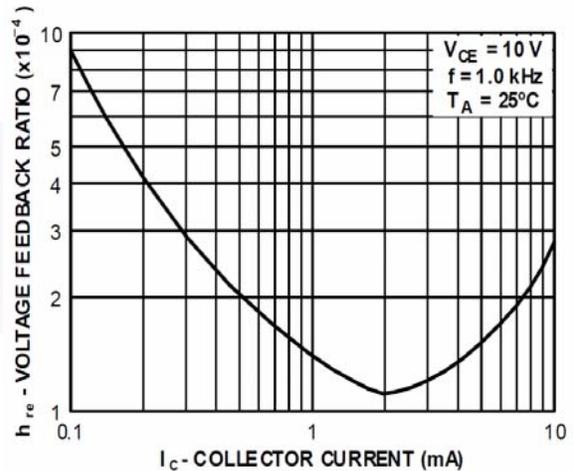
**Figure 21. Current Gain**



**Figure 22. Output Admittance**



**Figure 23. Input Impedance**



**Figure 24. Voltage Feedback Ratio**

## Physical Dimensions

### SC70 6L

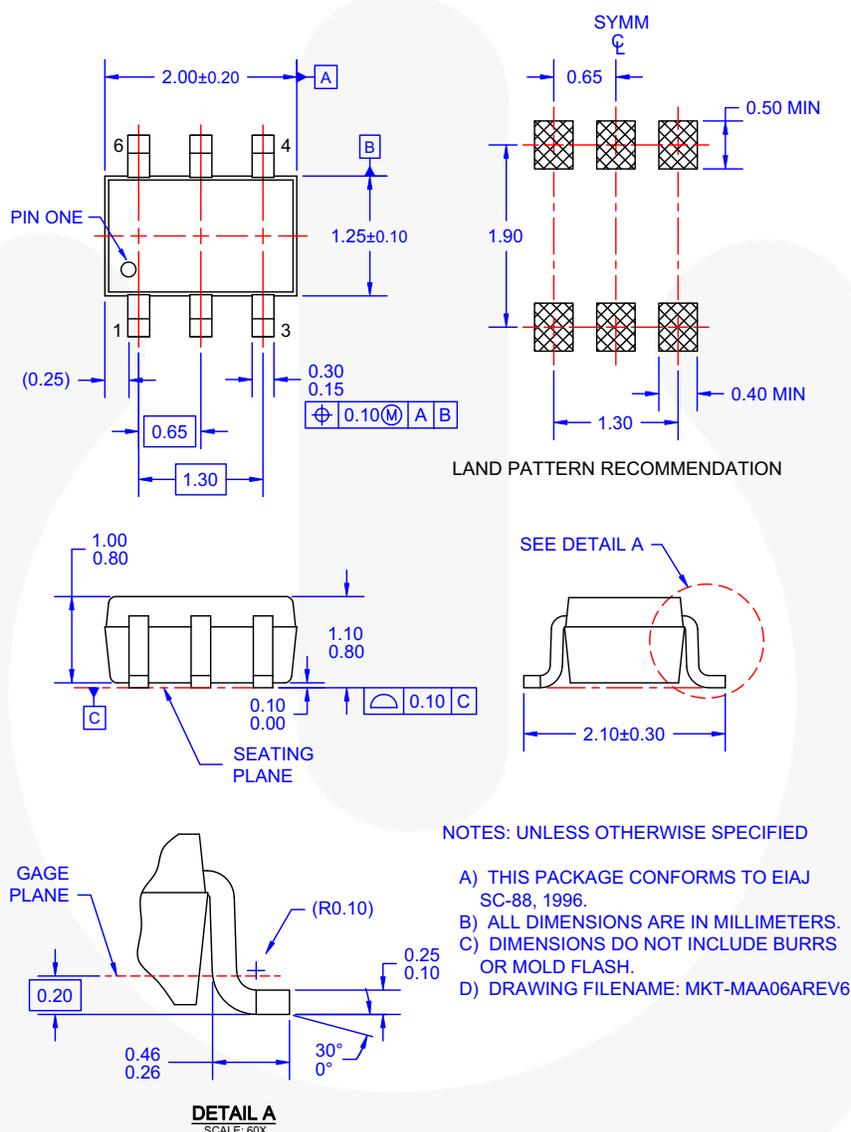


Figure 25. 6-LEAD, SC70, EIAJ SC-88, 1.25 MM WIDE (ACTIVE)

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Physical Dimensions (Continued)

SSOT 6L

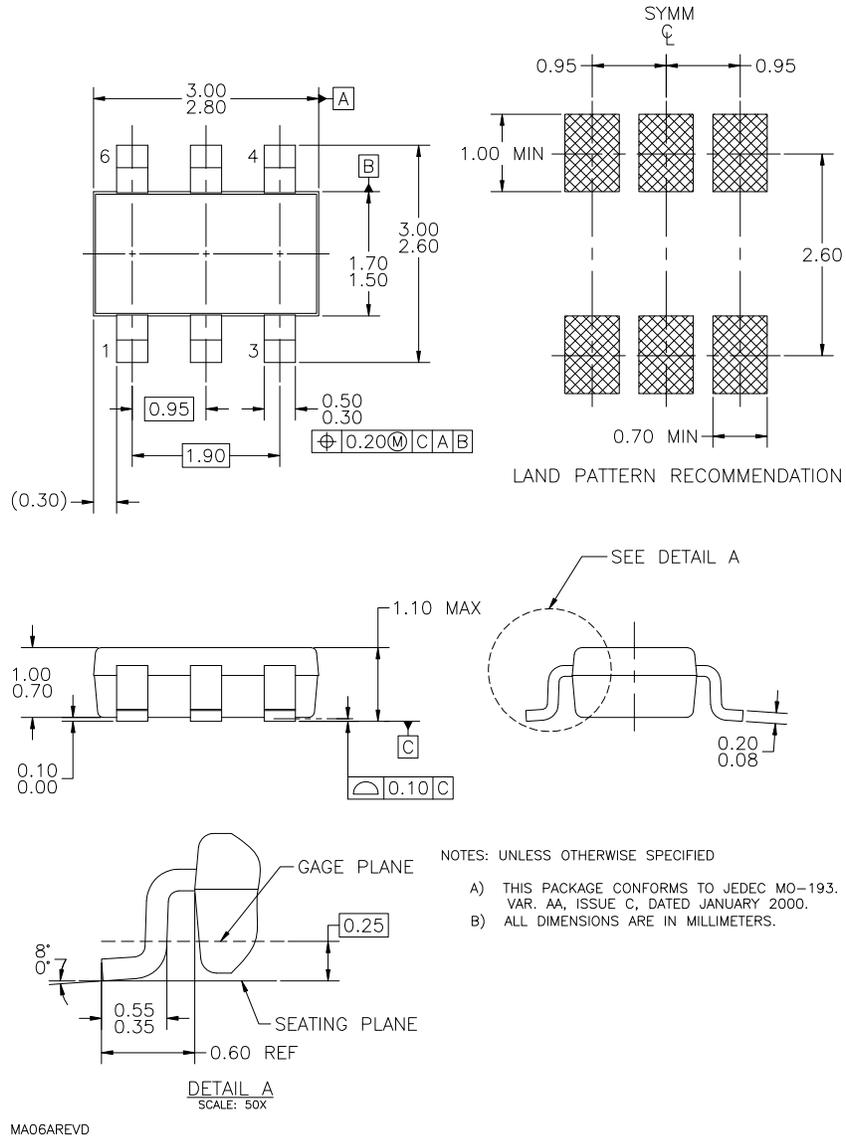


Figure 26. 6-LEAD, SUPER SOT-6, JEDEC MO-193, 1.6 MM WIDE (ACTIVE)

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Physical Dimensions (Continued)

SO 16L NB

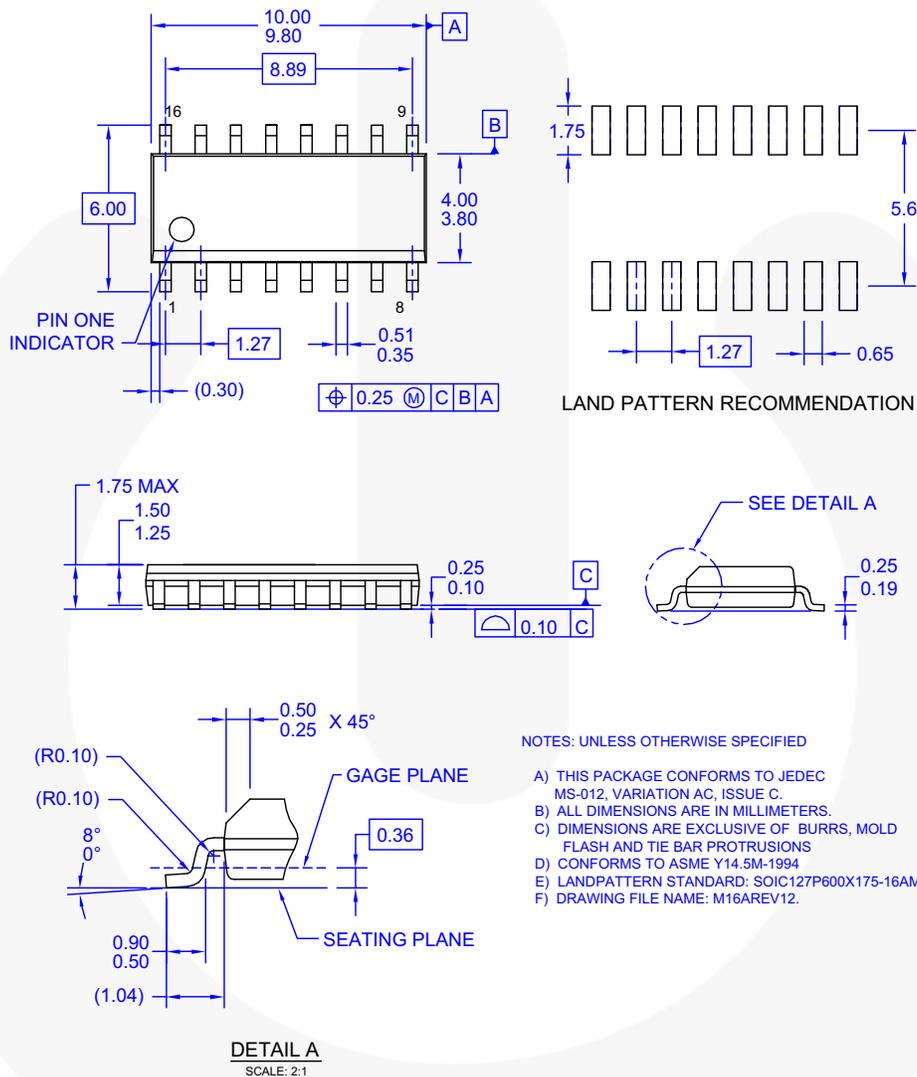


Figure 27. 16-LEAD, SOIC, JEDEC MS-012, 0.150 inch, NARROW BODY (ACTIVE)

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